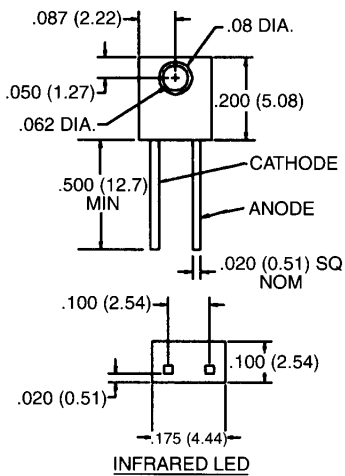
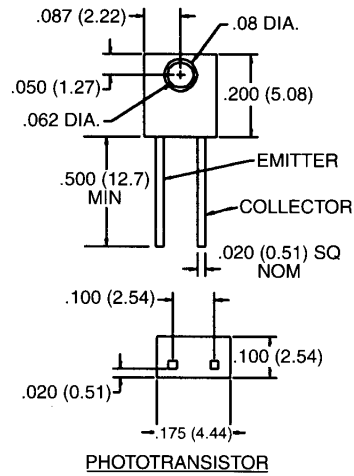


PACKAGE DIMENSIONS



ST2171



ST2171

NOTES:
1. DIMENSIONS ARE IN INCHES (mm).
2. TOLERANCE IS $\pm .010$ (.25)
UNLESS OTHERWISE SPECIFIED.

DESCRIPTION

The QPE1113 consists of a 940nm GaAs LED and a silicon phototransistor mounted in plastic sidelooker packages.

FEATURE

- Steel lead frames for improved reliability in solder mounting.
- Excellent optical-to-mechanical alignment.
- Wide emission/reception angle.
- Black plastic body allows easy recognition of sensor and filters ambient visible light.

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Specified) | |
|--|---|
| Storage Temperature | -40°C to $+100^\circ\text{C}$ |
| Operating Temperature | -40°C to $+100^\circ\text{C}$ |
| Soldering: | |
| Lead Temperature (Iron) | 240°C for 5 sec. ^(2,3,5) |
| Lead Temperature (Flow) | 260°C for 10 sec. ^(2,5) |
| INPUT DIODE | |
| Continuous Forward Current | 60 mA |
| Reverse Voltage | 5.0 Volts |
| Power Dissipation | 100 mW ⁽¹⁾ |
| OUTPUT TRANSISTOR | |
| Collector-Emitter Voltage | 30 Volts |
| Emitter-Collector Voltage | 5.0 Volts |
| Power Dissipation | 100 mW ⁽¹⁾ |

| ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless Otherwise Specified) (All measurements made under pulse conditions.) | | | | | | |
|---|-------------|------|------|------|---------------|---|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNITS | TEST CONDITIONS |
| INPUT DIODE | | | | | | |
| Forward Voltage | V_F | — | | 1.50 | V | $I_F = 20\text{ mA}$ |
| Reverse Leakage Current | I_R | — | | 100 | μA | $V_R = 5.0\text{ V}$ |
| OUTPUT TRANSISTOR | | | | | | |
| Collector-Emitter Breakdown | BV_{CEO} | 30 | | — | V | $I_C = 1.0\text{ mA}$, $E_e = 0$ |
| Collector-Emitter Leakage | I_{CEO} | — | | 100 | nA | $V_{CE} = 10.0\text{ V}$, $E_e = 0$ |
| COUPLED | | | | | | |
| On-State Collector Current | | | | | | |
| QPE1113 | $I_{C(ON)}$ | 0.30 | | — | mA | $I_F = 20\text{ mA}$, $V_{CC} = 5.0\text{ V}$, $D = .155^{(4,5)}$ |

| NOTES |
|---|
| 1. Derate power dissipation linearly 133 mW/°C above 25°C. |
| 2. RMA flux is recommended. |
| 3. Soldering iron tip 1/16" (1.6mm) minimum from case. |
| 4. D is the distance from lens tip to lens tip. |
| 5. As long as leads are not under any stress or spring tension. |



PLASTIC SIDELOOKER PAIR

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.